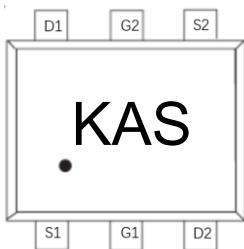


## Features

- Dual N-channel MOSFET
- Low gate threshold voltage and low  $R_{DS(ON)}$
- Low input capacitance and leakage
- Fast switching speed

## Application

- Load Switch for Portable Devices
- DC/DC Converter



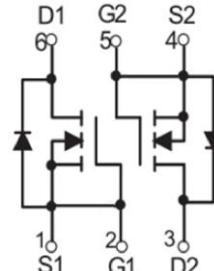
KAS: Device code

## Product Summary

$V_{DS}$	$R_{DS(ON)}$ TYP	$I_D$
60V	0.9Ω@10V	0.3A
	1.1Ω@4.5V	



SOT-563 top view



Schematic diagram



Halogen-Free

Marking and pin assignment

### Absolute Maximum Ratings (TA=25°C unless otherwise noted)

Symbol	Parameter	Rating	Unit
<b>Common Ratings (TC=25°C Unless Otherwise Noted)</b>			
$V_{DS}$	Drain-Source Breakdown Voltage	60	V
$V_{GS}$	Gate-Source Voltage	±20	V
$T_J$	Maximum Junction Temperature	150	°C
$T_{STG}$	Storage Temperature Range	-50 to 155	°C
$I_S$	Diode Continuous Forward Current	Tc=25°C 0.3	A
<b>Mounted on Large Heat Sink</b>			
$I_{DM}$	Pulse Drain Current Tested	Tc=25°C 1.2	A
$I_D$	Continuous Drain Current	Tc=25°C 0.3	A
$P_D$	Maximum Power Dissipation	Tc=25°C 0.15	W
$R_{θJA}$	Thermal Resistance Junction-to-Ambient	833	°C/W

### Ordering Information (Example)

Type	Package	Marking	Minimum Package(pcs)	Inner Box Quantity(pcs)	Outer Carton Quantity(pcs)	Delivery Mode
2N7002DT	SOT-563	KAS	3,000	45,000	180,000	7" reel

**Electrical Characteristics (T<sub>J</sub>=25°C unless otherwise noted)**

Symbol	Parameter	Condition	Min	Typ	Max	Unit
<b>Static Electrical Characteristics @ T<sub>J</sub> = 25°C (unless otherwise stated)</b>						
BV <sub>(BR)DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V, I <sub>D</sub> =250μA	60	--	--	V
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> =60V, V <sub>GS</sub> =0V	--	--	1	μA
I <sub>GSS</sub>	Gate-Body Leakage Current	V <sub>GS</sub> =±20V, V <sub>DS</sub> =0V	--	--	±100	nA
V <sub>GS(th)</sub>	Gate Threshold Voltage	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250μA	1.0	1.6	2.5	V
R <sub>DS(on)</sub>	Drain-Source On-State Resistance	V <sub>GS</sub> =10V, I <sub>D</sub> =0.34A	--	0.9	5.0	Ω
		V <sub>GS</sub> =5V, I <sub>D</sub> =0.2A	--	1.1	7.0	Ω

**Dynamic Electrical Characteristics @ T<sub>J</sub> = 25°C (unless otherwise stated)**

C <sub>ISS</sub>	Input Capacitance	V <sub>DS</sub> =30V, V <sub>GS</sub> =0V, f=1MHz	--	27	--	pF
C <sub>OSS</sub>	Output Capacitance		--	2.75	--	pF
C <sub>RSS</sub>	Reverse Transfer Capacitance		--	2	--	pF

**Switching Characteristics**

Q <sub>g</sub>	Total Gate Charge	V <sub>DS</sub> =30V, I <sub>D</sub> =0.34A, V <sub>GS</sub> =10V	--	1.7	--	nC
Q <sub>gs</sub>	Gate-Source Charge		--	0.57	--	nC
Q <sub>gd</sub>	Gate-Drain Charge		--	0.3	--	nC
t <sub>d(on)</sub>	Turn-on Delay Time	V <sub>DD</sub> =30V, I <sub>D</sub> =0.34A, V <sub>GS</sub> =10V, R <sub>G</sub> =3Ω	--	4	--	nS
t <sub>r</sub>	Turn-on Rise Time		--	19	--	nS
t <sub>d(off)</sub>	Turn-Off Delay Time		--	12	--	nS
t <sub>f</sub>	Turn-off fall Time		--	24	--	nS

**Source-Drain Diode Characteristics**

V <sub>SD</sub>	Forward on voltage	T <sub>j</sub> =25°C, I <sub>S</sub> =0.3A	--	--	1.2	V
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### Typical Operating Characteristics

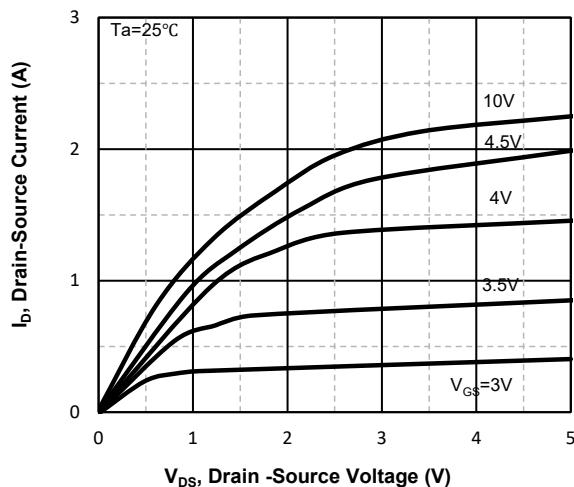


Fig1. Typical Output Characteristics

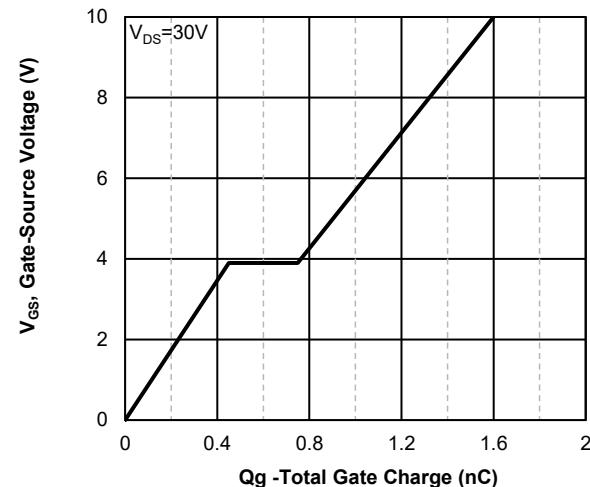


Fig2. Typical Gate Charge Vs.Gate-Source Voltage

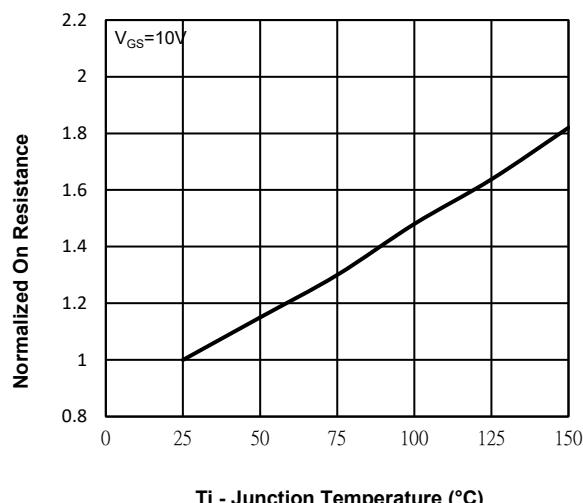


Fig3. Normalized On-Resistance Vs. Temperature

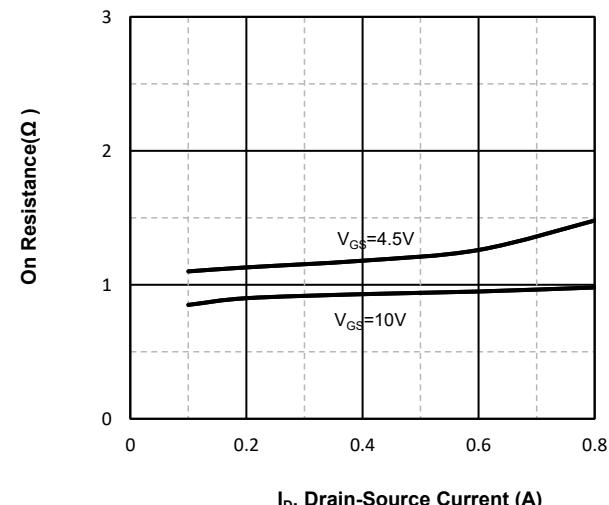


Fig4. On-Resistance Vs. Drain-Source Current

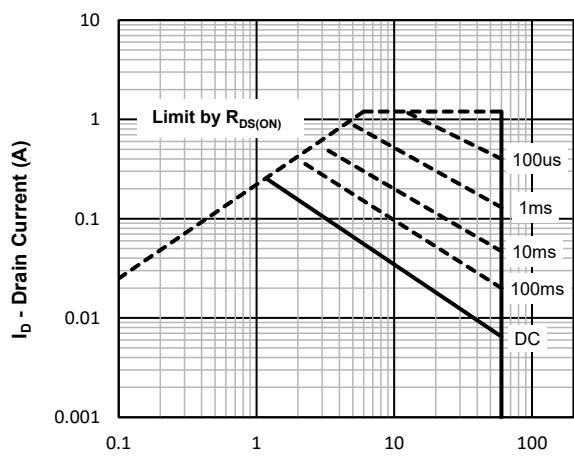


Fig5. Maximum Safe Operating Area

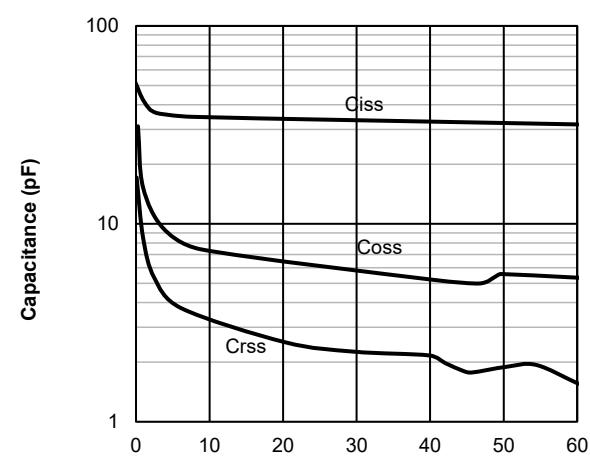
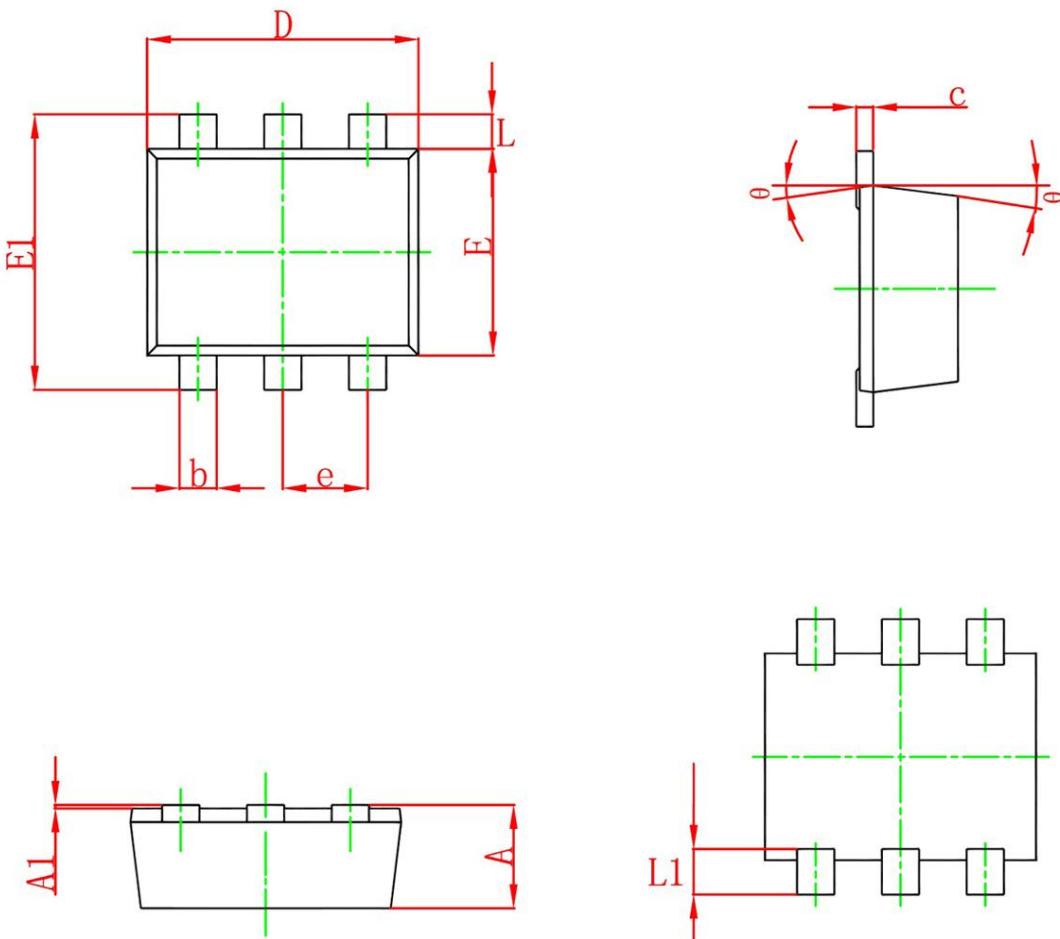


Fig6 Typical Capacitance Vs.Drain-Source Voltage

## SOT-563 Package information



Symbol	Dimensions in Millimeters(mm)		Dimensions In Inches	
	Min	Max	Min	Max
<b>A</b>	0.500	0.600	0.020	0.024
<b>A1</b>	0.000	0.050	0.000	0.002
<b>e</b>	0.450	0.550	0.018	0.022
<b>c</b>	0.090	0.180	0.004	0.007
<b>D</b>	1.500	1.700	0.059	0.067
<b>b</b>	0.170	0.270	0.007	0.011
<b>E</b>	1.100	1.300	0.043	0.051
<b>E1</b>	1.500	1.700	0.059	0.067
<b>L</b>	0.100	0.300	0.004	0.012
<b>L1</b>	0.200	0.400	0.008	0.016
$\theta$	10° REF.		10° REF.	